



[10191/3081]

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Appl. No. : 10/618,795 Confirmation No. 7307  
Applicant : Udo-Martin Gomez  
Filed : July 14, 2003  
Title : MICROSTRUCTURED COMPONENT AND METHOD FOR ITS  
MANUFACTURE  
Art Unit : 1772  
Examiner : Donald J. LONEY

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450 on:

Date: August 21, 2007

Signature: Chih Lin

**AMENDMENT**

Sir:

In response to the Office action of March 22, 2007, please amend the above-captioned application without prejudice as follows.

**Amendments to the Claims** are reflected in the listing of claims, which begins on page 2 of this paper

**Remarks** begin on page 4 of this paper.